# Onsemi

## Auto SPM<sup>®</sup> Series **Automotive 3-Phase IGBT Smart Power Module**

## **FAM65V05DF1**

### **General Description**

FAM65V05DF1 is an advanced Auto SPM module providing a fully-featured high-performance auxiliary inverter output stage for hybrid and electric vehicles. These modules integrate optimized gate drive of the built-in IGBTs to minimize EMI and losses, while also providing various protection features, in a compact  $12 \text{ cm}^2$ footprint.

#### Features

- Automotive SPM in 27 Pin DIP Package
- 650 V/50 A 3-phase IGBT Module with Low Loss IGBTs and Soft Recovery Diodes Optimized for Motor Control Applications
- · Integrated Gate Drivers with Internal VS connection, Under Voltage lockout, Over-current shutdown, Temperature Sensing Unit and Fault reporting
- Electrically Isolated AlN Substrate with Low Rθjc CONNU
- Module Serialization for Full Traceability
- UL Certified No. E209204 (UL 1557)
- Pb-Free, Halid Free and RoHS Compliant
- AEC & AQG324 Qualified and PPAP Capable

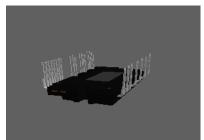
## **Applications and Benefits**

Automotive high voltage auxiliary motors such as air conditioning compressor and oil pump.

- Compact Design
- Simplified PCB Layout and Low E
- Simplified Assembly
- High Reliability

## **Related Resources**

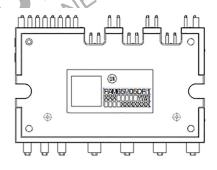
• AN-8422 - 650 V Auto SPM Series; Automotive 3-Phase IGBT Smart Power Module User's Guide



3D Package Drawing (Click to Activate 3D Content)

> ASPM27-CCA CASE MODCB

## MARKING DIAGRAM



ON	= <b>onsemi</b> Logo
FAM65V05DF1	= Specific Device Code
XXX	= Lot Number
Υ	= Year
WW	= Work Week
0000001	= Serial Number

## **ORDERING INFORMATION**

See detailed ordering and shipping information on page 7 of this data sheet.

## **PIN CONFIGURATION**

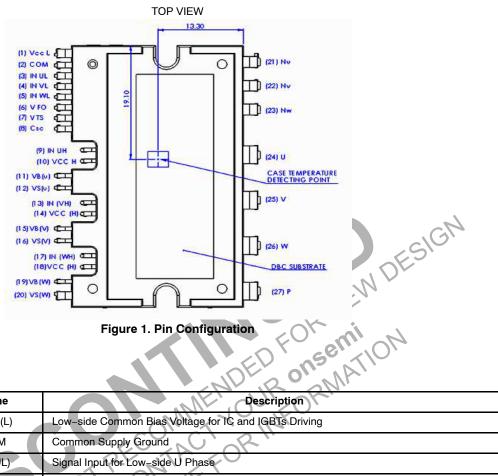


Figure 1. Pin Configuration

#### **PIN DESCRIPTION**

Pin Number	Name	Description
1	VCC (L)	Low-side Common Bias Voltage for IC and IGBTs Driving
2	СОМ	Common Supply Ground
3	IN (UL)	Signal Input for Low-side U Phase
4	IN (VL)	Signal Input for Low-side V Phase
5	IN (WL)	Signal Input for Low-side W Phase
6	VFO	Fault Output
7	VTS	Output for LVIC temperature sense
8	ČSC	Capacitor (Low-pass Filter) for Short-Current Detection Input
9 S	IN (UH)	Signal Input for High-side U Phase
10	VCC (H)	High-side Common Bias Voltage for IC and IGBTs Driving
11	VB (U)	High-side Bias Voltage for U Phase IGBT Driving
12	VS (U)	High-side Bias Voltage Ground for U Phase IGBT Driving
13	IN (VH)	Signal Input for High-side V Phase
14	VCC (H)	High-side Common Bias Voltage for IC and IGBTs Driving
15	VB (V)	High-side Bias Voltage for V Phase IGBT Driving
16	VS (V)	High-side Bias Voltage Ground for V Phase IGBT Driving
17	IN (WH)	Signal Input for High-side W Phase
18	VCC (H)	High-side Common Bias Voltage for IC and IGBTs Driving
19	VB (W)	High-side Bias Voltage for W Phase IGBT Driving
20	VS (W)	High-side Bias Voltage Ground for W Phase IGBT Driving
21	NU	Negative DC-Link Input for U Phase
22	NV	Negative DC-Link Input for V Phase

#### PIN DESCRIPTION (continued)

Pin Number	Name	Description
23	NW	Negative DC-Link Input for W Phase
24	U	Output for U Phase
25	V	Output for V Phase
26	W	Output for W Phase
27	Р	Positive DC–Link Input

## INTERNAL EQUIVALENT CIRCUIT AND INPUT/OUTPUT PINS

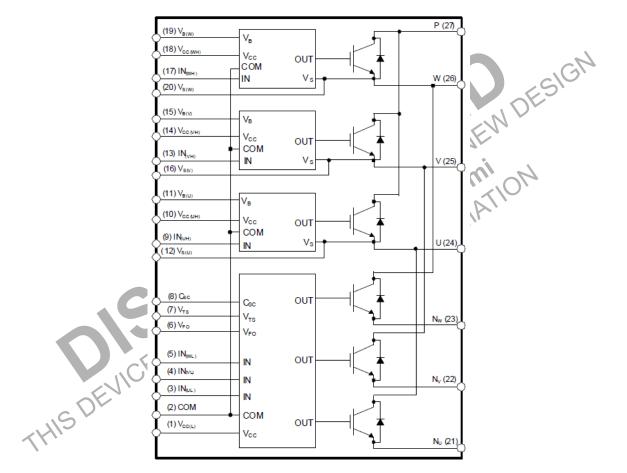


Figure 2. Schematic

## GATE DRIVERS BLOCK DIAGRAM

## High Side Gate Driver (x3 Single Channel)

- Control circuit under-voltage (UV) protection
- 3.3 V/5 V CMOS/LSTTL compatible, Schmitt trigger input

Fault Output
3.3 V/5 V CMOS/LSTTL compatible, Schmitt trigger

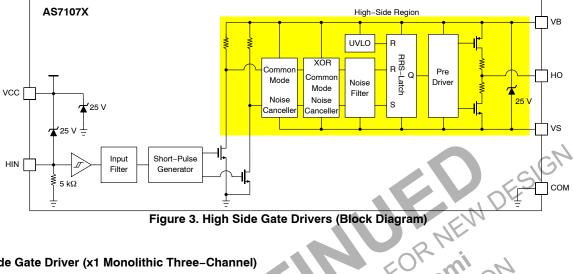


Figure 3. High Side Gate Drivers (Block Diagram)

Fault Output

input

## Low Side Gate Driver (x1 Monolithic Three-Channel)

- Control circuit under-voltage (UV) protection
- Short circuit protection (SC)
- Temperature sensing unit
  - U-Phase LINU - T LOU V-Phase LOV -LINV W-Phase VDD **B** Pre LINW Input Filter Matching Delay Restar LOW Driver 5 kΩ 🔶 80 mA TSD TSU FO TSU UVLO (Temperature Sensing Unit) Timer Filter CSC CSC Filter 0.5 \ vcc COM 🛱 25 V AS4743X

Figure 4. Low Side Gate Drivers (Block Diagram)

#### ABSOLUTE MAXIMUM RATINGS (T<sub>J</sub> = 25°C, unless otherwise specified)

Symbol	Parameter	Conditions	Rating	Unit
	_			

## **INVERTER PART**

V <sub>PN</sub>	Supply Voltage	Applied between P– $N_U$ , $N_V$ , $N_W$	500	V
V <sub>PN(Surge)</sub>	Supply Voltage (Surge)	Applied between P- $N_U$ , $N_V$ , $N_W$ dI/dt $\leq$ 3 A/ns	575	V
V <sub>CES</sub>	Collector-Emitter Voltage at the IGBT/Diode	$T_{J} = 25^{\circ}C$	650	V
±I <sub>C</sub>	IGBT Continuous Collector Current	T <sub>C</sub> = 100°C, T <sub>Jmax</sub> = 175°C (Note 1)	50	A
±I <sub>CP</sub>	IGBT Peak Collector Pulse Current	$T_{C}$ = 100°C, $T_{Jmax}$ = 175°C, $V_{CC}$ = $V_{BS}$ = 15 V, less than 1 ms (Note 6)	150	A
P <sub>C</sub>	Collector Dissipation	T <sub>C</sub> = 25°C per IGBT	333	W
TJ	Junction Temperature	IGBT/Diode	-40 ~ +175	°C
		Driver IC	-40 ~ +150	°C

#### CONTROL PART

V <sub>CC</sub>	Control Supply Voltage	Applied between $V_{CC(H)}$ , $V_{CC(L)}$ – COM	20	V			
V <sub>BS</sub>	High-side Control Bias Voltage	$ \begin{array}{l} \mbox{Applied between } V_{B(U)} - V_{S(U)}, \\ V_{B(V)} - V_{S(V)}, \ V_{B(W)} - V_{S(W)} \end{array} $	NF 20	V			
V <sub>IN</sub>	Input Signal Voltage	Applied between IN <sub>(UH)</sub> , IN <sub>(VH)</sub> , IN <sub>(WH)</sub> , IN <sub>(UL)</sub> , IN <sub>(UL)</sub> , IN <sub>(VL)</sub> , IN <sub>(WL)</sub> – COM	+0.3 ~ V <sub>CC</sub> + 0.3	V			
V <sub>FO</sub>	Fault Output Supply Voltage	Applied between V <sub>FO</sub> – COM	$-0.3 \sim V_{CC} + 0.3$	V			
I <sub>FO</sub>	Fault Output Current	Sink Current at V <sub>FO</sub> Pin	5	mA			
V <sub>SC</sub>	Current Sensing Input Voltage	Applied between C <sub>SC</sub> - COM	$-0.3 \sim V_{CC} + 0.3$	V			
V <sub>TS</sub>	Temperature Sense Unit		$-0.3 \sim 2/3 \times V_{CC}$	V			
TOTAL SYSTE	OTAL SYSTEM						

#### TOTAL SYSTEM

T <sub>STG</sub>	Storage Temperature	-40 ~ 125	°C
V <sub>ISO</sub>	Isolation Voltage 60 Hz, Sinusoidal, AC 1 minute, Connection Pins to heat sink plate	2500	V <sub>rms</sub>
T <sub>LEAD</sub>	Max Lead Temperature at the Base of the Package During pcb Assembly	200	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### PACKAGE CHARACTERISTICS

Symbol	Parameter	Conditions	Тур	Мах	Unit
R <sub>th(j-c)Q</sub>	Junction to Case Thermal	Inverter IGBT part (per IGBT)	-	0.45	°C/W
R <sub>th(j-c)F</sub>	Resistance (Note 2)	Inverter FWD part (per DIODE)	-	0.85	°C/W
Lσ	Package Stray Inductance	P to N <sub>U</sub> , N <sub>V</sub> , N <sub>W</sub> (Note 3)	24	-	nH

1. Current limited by package terminal, defined by design.

2. Case temperature measured below the package at the chip center, compliant with MIL STD 883-1012.1 (single chip heating), DBC discoloration allowed, please refer to application note <u>AN-9190</u> (*Impact of DBC Oxidation on SPM Module Performance*).
 Stray inductance per phase measured per IEC 60747–15.

### **ELECTRICAL CHARACTERISTICS**

Syn	Symbol Parameter Test Conditions		Test Conditions	Min	Тур	Max	Unit
VERTE	ER PART (	T <sub>J</sub> as specified)					
V <sub>CE</sub>	(SAT)	Collector-Emitter Leakage Current	$V_{CC} = V_{BS} = 15 \text{ V}, V_{IN} = 5 \text{ V}$ $I_C = 50 \text{ A}, T_J = 25^{\circ}\text{C}$	-	1.65	-	V
			$V_{CC} = V_{BS} = 15 \text{ V}, V_{IN} = 5 \text{ V}$ $I_C = 50 \text{ A}, T_J = 125^{\circ}\text{C}$	-	1.9	2.4	V
N	/ <sub>F</sub>	FWD Forward Voltage	$V_{IN} = 0 \text{ V}, I_F = 30 \text{ A}, T_J = 25^{\circ}\text{C}$	-	2.1	-	V
			$V_{IN}$ = 0 V, I <sub>F</sub> = 30 A, T <sub>J</sub> = 125°C	-	1.9	2.5	V
HS	t <sub>ON</sub>	High Side Switching Times	$V_{PN} = 300 \text{ V}, V_{CC} = V_{BS} = 15 \text{ V}$	1	0.73	-	μs
	t <sub>C(ON)</sub>		I <sub>C</sub> = 50 A V <sub>IN</sub> = 0 V ↔ 5 V, Ls = 55 nH,	-	0.12	-	
	t <sub>OFF</sub>		Inductive Load T,j = 25°C (Notes 4, 5)	-	0.80	-	
	t <sub>C(OFF)</sub>			- (	0.14	-	
	t <sub>rr</sub>				0.10	2	
	t <sub>ON</sub>	High Side Switching Times	$V_{PN} = 300 \text{ V}, V_{CC} = V_{BS} = 15 \text{ V}$	-	0.70	<u> </u>	μs
	t <sub>C(ON)</sub>		I <sub>C</sub> = 50 A V <sub>IN</sub> = 0 V ↔ 5 V, Ls = 55 nH,	-	0.15	-	
	t <sub>OFF</sub>		Inductive Load T <sub>.1</sub> = 125°C (Notes 4, 5)		0.87	-	
	t <sub>C(OFF)</sub>			7-	0.19	-	
	trr		-Or	in.	0.20	-	
LS	t <sub>ON</sub>	Low Side Switching Times	$V_{PN} = 300 V, V_{CC} = V_{BS} = 15 V$		0.68	-	μs
	t <sub>C(ON)</sub>		$V_{IN} = 0 V \leftrightarrow 5 V. Ls = 55 nH.$	NP'	0.20	-	
	t <sub>OFF</sub>		Inductive Load T <sub>J</sub> = 25°C (Notes 4, 5)		0.86	-	
	t <sub>C(OFF)</sub>		MANNYOUTEON	-	0.19	-	
	t <sub>rr</sub>			-	0.14	-	
	t <sub>ON</sub>	Low Side Switching Times	$V_{PN} = 300 V, V_{CC} = V_{BS} = 15 V$	-	0.64	-	μs
	t <sub>C(ON)</sub>		IC = 50 A V <sub>IN</sub> = 0 V ↔ 5 V, Ls = 55 nH,	-	0.24	-	
	t <sub>OFF</sub>	NUC	Inductive Load T <sub>J</sub> = 125°C (Notes 4, 5)	-	0.88	-	
	t <sub>C(OFF)</sub>	NCEISNOS	NTK	-	0.23	-	
	trr	I CE E C	EL	-	0.20	-	
SC	WT	Short Circuit Withstand Time (Note 6)	V <sub>CC</sub> = V <sub>BS</sub> = 15 V, V <sub>PN</sub> = 450 V, T <sub>J</sub> = 25°C, Non-repetitive	-	5	-	μs
IC	ES	Collector-Emitter Leakage Current for IGBT and Diode in Parallel	T <sub>J</sub> = 25°C, V <sub>CE</sub> = 650 V	-	3	-	μA
	-		T <sub>J</sub> = 125°C, V <sub>CE</sub> = 650 V	-	150	1500	μA

#### ELECTRICAL CHARACTERISTICS (continued)

Symbol	Parameter	Test Condi	tions	Min	Тур	Max	Unit
	$\Gamma$ (T <sub>J</sub> = -40°C to 150°C, unless other	wise specified, typical value	es specified at $T_J = 1$	25°C)			
IQCCL	Quiescent V <sub>CC</sub> Supply Current	V <sub>CC</sub> = 15 V, IN <sub>(UL, VL, WL)</sub> = 0 V	V <sub>CC(L)</sub> – COM	-	-	5	mA
IQCCH		V <sub>CC</sub> = 15 V, IN <sub>(UH, VH, WH)</sub> = 0 V	V <sub>CC(H)</sub> – COM	-	-	150	μA
I <sub>PCCH</sub>	Operating V <sub>CC</sub> Supply Current	$\begin{array}{l} V_{CC(UH, VH, WH)} = 15 \ V \\ f_{PWM} = 20 \ kHz \\ Duty = 50\%, \ applied \ to \\ one \ PWM \ signal \ input \\ for \ high-side \end{array}$	$\begin{array}{l} V_{CC(UH)}-COM\\ V_{CC(VH)}-COM\\ V_{CC(WH)}-COM \end{array}$	-	-	0.30	mA
IQCCL		$\begin{array}{l} V_{CC(UH, VH, WH)} = 15 \ V \\ f_{PWM} = 20 \ kHz \\ Duty = 50\%, \ applied \ to \\ one \ PWM \ signal \ input \\ for \ low-side \end{array}$	V <sub>CC(L)</sub> – COM	-	-	8.5	mA
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> Supply Current	V <sub>BS</sub> = 15 V, IN <sub>(UH, VH, WH)</sub> = 0 V	$ \begin{array}{l} V_{B(U)} - V_{S(U)} \\ V_{B(V)} - V_{S(V)} \\ V_{B(W)} - V_{S(W)} \end{array} $	-	OF	150	μΑ
I <sub>PBS</sub>	Operating V <sub>BS</sub> Supply Current	$V_{CC} = V_{BC} = 15 \text{ V}$ $IN_{(UH, VH, WH)} = 0 \text{ V}$	$ \begin{array}{l} V_{B(U)} - V_{S(U)} \\ V_{B(V)} - V_{S(V)} \\ V_{B(W)} - V_{S(W)} \end{array} $	JEN	_	4.5	mA
V <sub>FOH</sub>	Fault Output Voltage	V <sub>SC</sub> = 0 V, V <sub>FO</sub> Circuit: 4.	7 k $\Omega$ to 5 V Pull-up	4.5	4	-	V
V <sub>FOL</sub>		V <sub>SC</sub> = 1 V, V <sub>FO</sub> Circuit: 4.	7 k $\Omega$ to 5 V Pull–up	~\	<u> 7</u> C	0.5	V
V <sub>SC(ref)</sub>	Short-Circuit Trip Level	V <sub>CC</sub> = 15 V (Note 7)	C <sub>SC</sub> -COM	0.45	0.52	0.59	V
UV <sub>CCD</sub>	Supply Circuit Under-	Detection Level, $T_J = 125$	°C I P	10.6	-	13.2	V
UV <sub>CCR</sub>	Voltage Protection	Reset Level, T <sub>J</sub> = 125°C	OSTEO	11.0	-	13.8	V
UV <sub>BSD</sub>		Detection Level, $T_J = 125$	°C	10.5	-	13	V
UV <sub>BSR</sub>		Reset Level, T <sub>J</sub> = 125°C	)`	10.8	-	13.3	V
t <sub>FOD</sub>	Fault-out Pulse Width	COP IE		-	60	-	μs
V <sub>TS</sub>	LVIC Temperature Sensing Voltage Output	V <sub>CC(L)</sub> = 15 V, T <sub>LVIC</sub> =125	°C (Note 8)	-	2.4	-	V
V <sub>IN(ON)</sub>	ON Threshold Voltage	Applied between IN <sub>(UH)</sub> , I	N <sub>(VH)</sub> , IN <sub>(WH)</sub> ,	-	2.6	3.1	V
V <sub>IN(OFF)</sub>	OFF Threshold Voltage	$(IN_{(UL)}, IN_{(VL)}, IN_{(WL)}) = CC$	ואר	0.9	1.2	-	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. t<sub>ON</sub> and t<sub>OFF</sub> include the propagation delay time of the internal drive IC. t<sub>C(ON)</sub> and t<sub>C(OFF)</sub> are the switching times of IGBT itself under the given gate driving condition internally. Refer to Figure 6 for detailed information.
5. Stray inductance Ls is sum of stray inductance of module & setup.
6. Visition by design and basely besting and the setup.

Verified by design and bench-testing only.
 Short-circuit current protection is functional only for low side.

8. T<sub>LVIC</sub> is the junction temperature of the LVIC itself.

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number Top Marking		Package	Shipping
FAM65V05DF1	FAM65V05DF1	ASPM27-CCA	10 Units/Tube

FAM65V05DF1

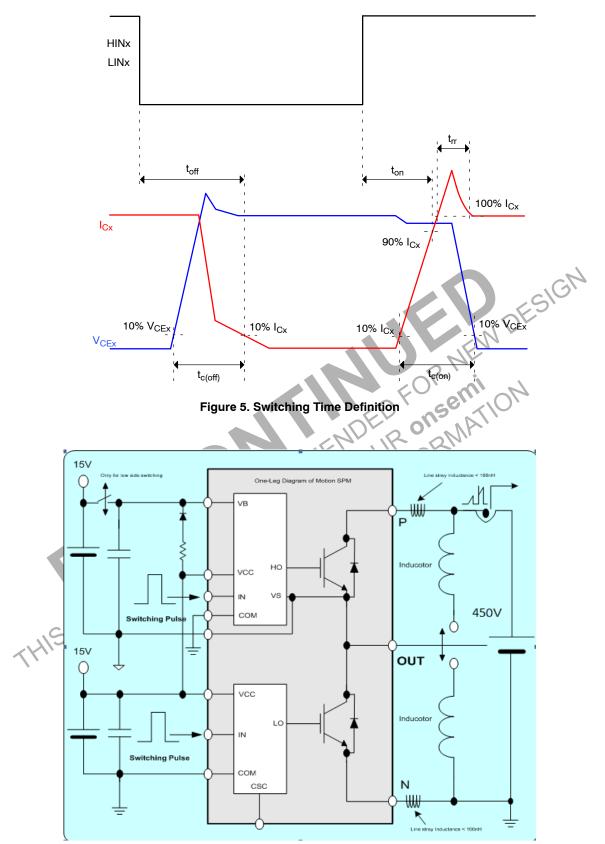


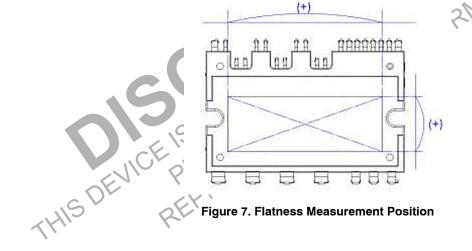
Figure 6. Switching Evaluation Circuit

## **RECOMMENDED OPERATING CONDITIONS**

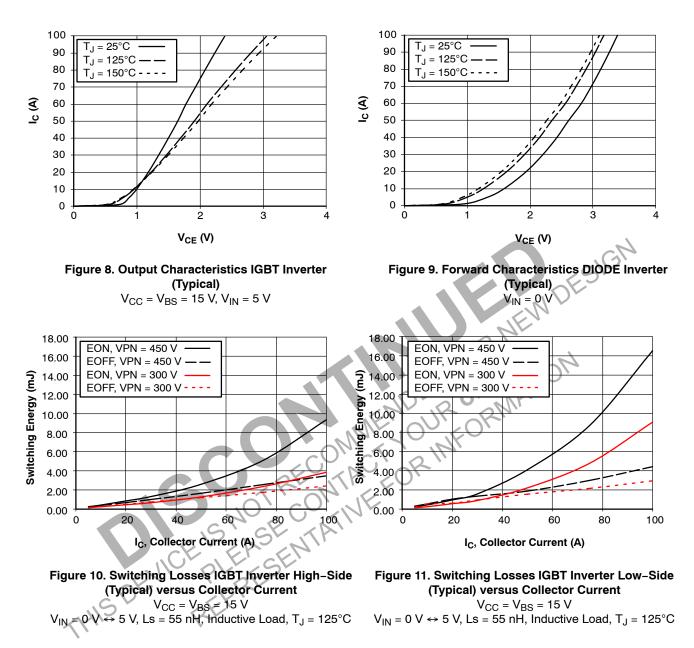
Symbol	Parameter	Conditions	Min	Max	Мах	Unit
V <sub>PN</sub>	Supply Voltage	Applied between P – $N_U$ , $N_V$ , $N_W$	-	450	500	V
V <sub>CC</sub>	Control Supply Voltage	Applied between $V_{CC(H)}$ , $V_{CC(L)}$ – COM	13.5	15	16.5	V
$V_{BS}$	High-side Bias Voltage	$ \begin{array}{l} \mbox{Applied between } V_{B(U)} - V_{S(U)}, \\ V_{B(V)} - V_{S(V)}, \ V_{B(W)} - V_{S(W)} \end{array} $	13.3	15	18.5	V
dV <sub>CC</sub> /dt, dV <sub>BS</sub> /dt	Control Supply Variation		-1	_	1	V/μs
t <sub>dead</sub>	Blanking Time for Preventing Arm-short	For Each Input Signal	1.0	-	-	μs
f <sub>PWM</sub>	PWM Input Signal	T <sub>C</sub> = 125°C	-	-	20	kHz
V <sub>SEN</sub>	Voltage for Current Sensing	Applied between N <sub>U</sub> , N <sub>V</sub> , N <sub>W</sub> – COM (Including surge voltage)	-4	-	4	V
TJ	Junction Temperature		-40	-	150	°C

## **MECHANICAL CHARACTERISTICS AND RATINGS**

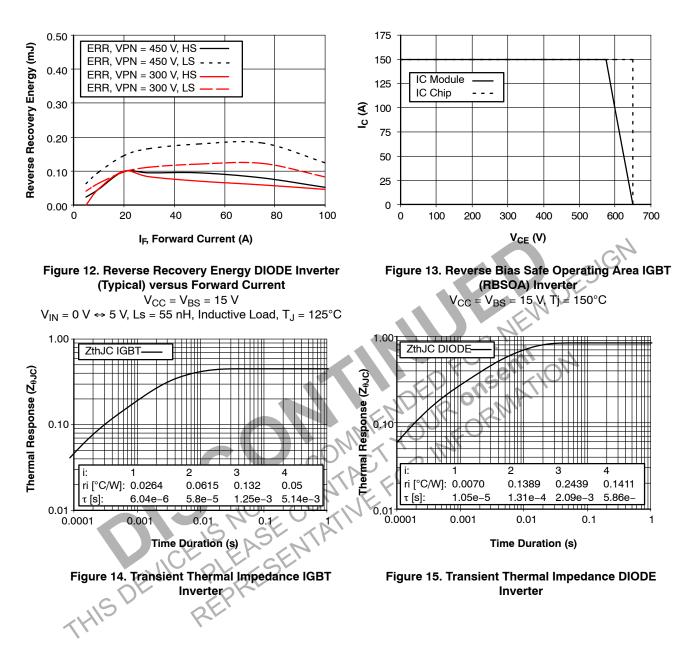
			Limits			
Parameter	Conditions	Conditions	Min	Тур	Max	Unit
Mounting Torque	Mounting Screw: – M3	Recommended 0.62 N·m	0.52	0.62	0.80	N∙m
Device Flatness		R		-	+150	μm
Weight		FO.	- (fri	15	-	g



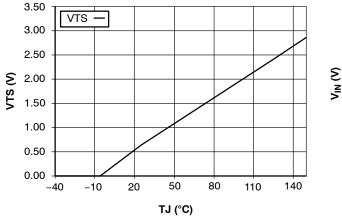
## **TYPICAL INVERTER CHARACTERISTICS**



## TYPICAL INVERTER CHARACTERISTICS (continued)



## **TYPICAL CONTROLLER CHARACTERISTICS**



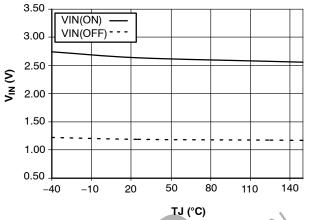
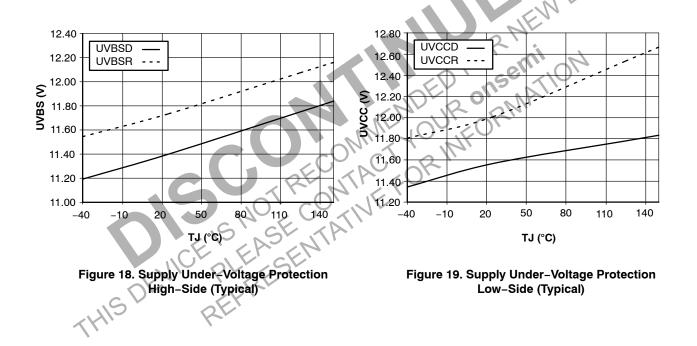


Figure 16. Temperature Profile of V<sub>TS</sub> (Typical)

Figure 17. Threshold Voltage versus Temperature



## TIMING CHART PROTECTIVE FUNCTION

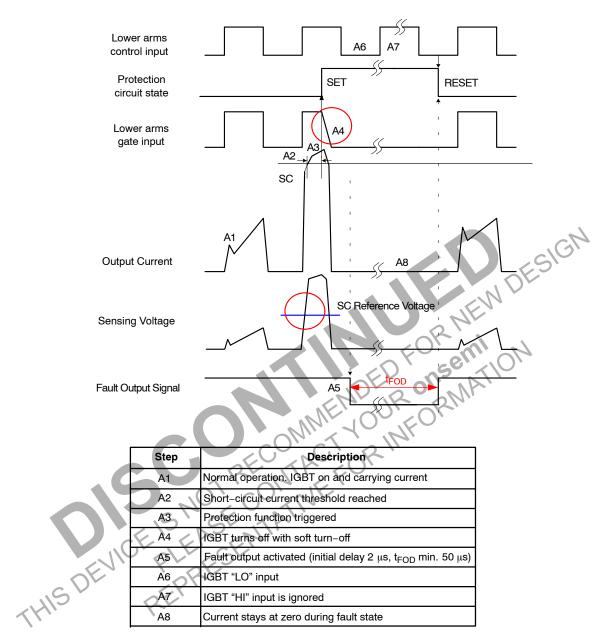
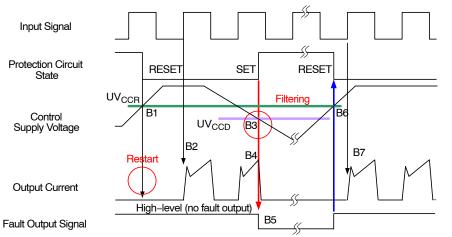
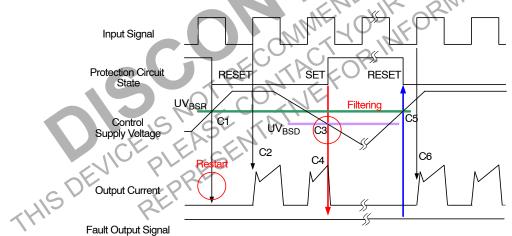


Figure 20. Short-Circuit Current Protection



Step	Description			
B1	Control supply voltage rises above reset voltage UV <sub>CCR</sub>			
B2	Normal operation. IGBT on and carrying current			
B3	Control supply voltage falls below detection voltage UV <sub>CCD</sub>			
B4	Filtered supply voltage falls below UV <sub>CCD</sub> and IGBT turns off			
B5	Fault output activated (initial delay 2 µs, t <sub>FOD</sub> min. 50ms)			
B6	Control supply voltage rises above reset voltage UV <sub>CCR</sub>			
B7	IGBT "HI" input is followed after fault output duration and supply voltage rise			
Figure 21. Under-Voltage Protection (Low-side)				

## Figure 21. Under-Voltage Protection (Low-side)



#### Fault Output Signal

Step	Description		
C1	Control supply voltage rises above reset voltage $UV_CCR$		
C2	Normal operation. IGBT on and carrying current		
C3	Control supply voltage falls below detection voltage $UV_{CCD}$		
C4	Filtered supply voltage falls below UVCCD and IGBT turns off		
C5	Control supply voltage rises above reset voltage $UV_CCR$		
C6	IGBT "HI" input is followed after supply voltage rise		

Figure 22. Under-Voltage Protection (High-side)

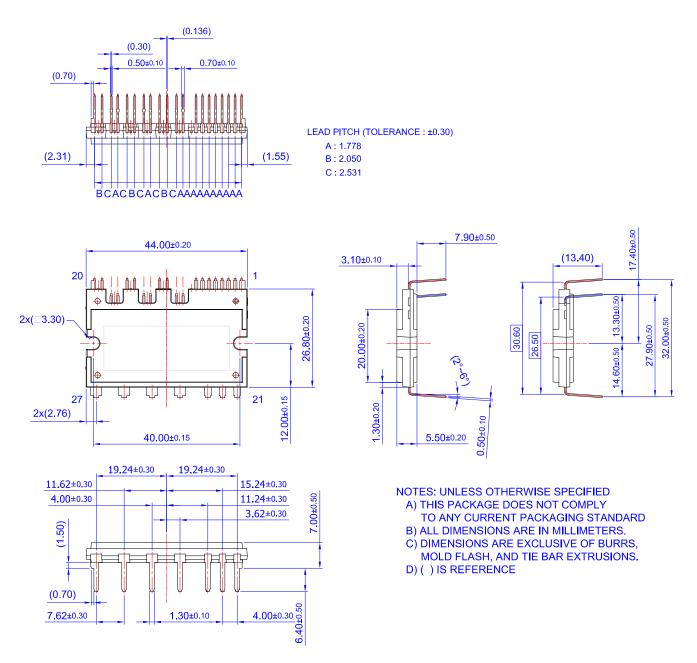
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DESCRIPTION:	27LD MODULE PDD STD		PAGE 1 OF 1					

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